

Low Cost Power/Energy IC with Pulse Output

Features

- Single Chip; Power Measurement Solution
- Energy Data Linearity: ±0.1% of Reading over 1000:1 Dynamic Range
- On-Chip functions: Measures Energy and Performs Energy-to-Pulse Conversions
- Meets Accuracy Spec for IEC 687/1036
- High Pass Filter Option
- Four Input Ranges for Current Channel
- On-Chip 2.5 V Reference (25 ppm/°C typ)
- Pulse Outputs for Stepper Motor or Mechanical Counter
- On-Chip Energy Direction Indicator
- Ground Referenced Input Signals with Single Supply
- High Frequency Output for Calibration
- On-Chip Power-on Reset
- Power Supply Configurations:

VA+ = +5 V; AGND = 0 V; VD+ = +3.3 V to 5 V

Description

The CS5466 is a low cost power meter solution combining two $\Delta\Sigma$ Analog-to-Digital Converters (ADC)'s, an energy-to-frequency converter, and energy pulse outputs on a single chip. It is designed to accurately measure and calculate energy for single phase 2- or 3-wire power metering applications with minimal external components.

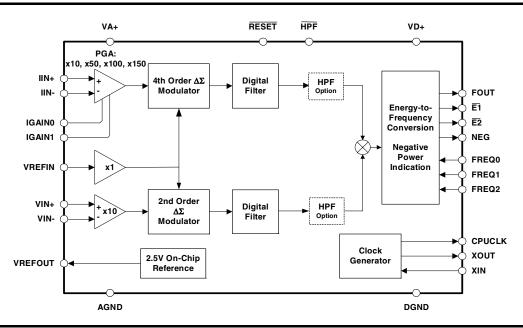
Low frequency energy outputs, $\overline{E1}$ and $\overline{E2}$, supply average real power and can be used to drive a stepper motor or a mechanical counter; the high frequency energy output FOUT can be used for calibration; and NEG indicates negative power.

The CS5466 has configuration pins which allow for direct configuration of pulse output frequency, current channel input range, and high pass filter enable option.

The CS5466 also has a power-on reset function which holds the part in reset until the supply reaches an operable level.

ORDERING INFORMATION

CS5466-ISZ -40° to 85° C 24-pin SSOP Lead Free



Preliminary Product Information

This document contains information for a new product.

Cirrus Logic reserves the right to modify this product without notice.





TABLE OF CONTENTS

2. PIN DESCRIPTION	1.	. GENERAL DESCRIPTION	3
RECOMMENDED OPERATING CONDITIONS ANALOG CHARACTERISTICS VOLTAGE REFERENCE DIGITAL CHARACTERISTICS SWITCHING CHARACTERISTICS ABSOLUTE MAXIMUM RATINGS 4. THEORY OF OPERATION 4.1 Digital Filters 4.2 Average Real Power Computation 5. FUNCTIONAL DESCRIPTION 11 5.1 Analog Inputs 5.1.1 Voltage Channel 11 5.1.2 Current Channel 11 5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of E1 and E2 11 5.3.4 Absolute Max Frequency on E1 and E2 11 5.3.5 E1 and E2 Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency of E1 5.6 Oscillator Characteristics 5.7 Basic Application Circuit 6. PACKAGE DIMENSIONS 15 Figure 1. Timing Diagram for E1, E2 and FOUT Figure 3. Oscillator Connection Diagram 14 LIST OF TABLES Table 1. Current Channel PGA Setting 15 Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency of E1, E2 and FOUT 12 13 14 15 15 16 16 17 17 18 19 11 11 11 11 11 11 11 11 11 11 11 11	2.	. PIN DESCRIPTION	4
RECOMMENDED OPERATING CONDITIONS ANALOG CHARACTERISTICS VOLTAGE REFERENCE DIGITAL CHARACTERISTICS SWITCHING CHARACTERISTICS ABSOLUTE MAXIMUM RATINGS 4. THEORY OF OPERATION 4.1 Digital Filters 4.2 Average Real Power Computation 5. FUNCTIONAL DESCRIPTION 11 5.1 Analog Inputs 5.1.1 Voltage Channel 11 5.1.2 Current Channel 11 5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of E1 and E2 11 5.3.4 Absolute Max Frequency on E1 and E2 11 5.3.5 E1 and E2 Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency of E1 5.6 Oscillator Characteristics 5.7 Basic Application Circuit 6. PACKAGE DIMENSIONS 15 Figure 1. Timing Diagram for E1, E2 and FOUT Figure 3. Oscillator Connection Diagram 14 LIST OF TABLES Table 1. Current Channel PGA Setting 15 Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency of E1, E2 and FOUT 12 13 14 15 15 16 16 17 17 18 19 11 11 11 11 11 11 11 11 11 11 11 11	3.	. CHARACTERISTICS/SPECIFICATIONS	5
VOLTAGE REFERENCE. 26 DIGITAL CHARACTERISTICS. 5 SWITCHING CHARACTERISTICS. 6 ABSOLUTE MAXIMUM RATINGS. .9 4. THEORY OF OPERATION. 10 4.1 Digital Filters. 16 4.2 Average Real Power Computation. 11 5. FUNCTIONAL DESCRIPTION. 11 5.1 Analog Inputs. 11 5.1.1 Voltage Channel. 11 5.1.2 Current Channel. 11 5.2 High-Pass Filter. 11 5.3 Energy Pulse Outputs. 11 5.3.1 Pulse Output Format. 11 5.3.2 Selecting Frequency of ET and E2. 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2. 12 5.3.5 E1 and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 13 5.5 Power-on Reset 13 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 13 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF TABLES Table 1. Current Channel PGA Setting 11		RECOMMENDED OPERATING CONDITIONS	<u>E</u>
DIGITAL CHARACTERISTICS 7 SWITCHING CHARACTERISTICS 8 ABSOLUTE MAXIMUM RATINGS 9 4. THEORY OF OPERATION 10 4.1 Digital Filters 11 4.2 Average Real Power Computation 16 5. FUNCTIONAL DESCRIPTION 11 5.1 Analog Inputs 11 5.1 Analog Inputs 11 5.1.2 Current Channel 11 5.2 High-Pass Filter 11 5.3 Energy Pulse Outputs 11 5.3.1 Pulse Output Format 11 5.3.2 Selecting Frequency of ET and E2 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on ET and E2 12 5.3.5 ET and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 12 5.5 Power-on Reset 15 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 15 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10		ANALOG CHARACTERISTICS	<u>E</u>
SWITCHING CHARACTERISTICS ABSOLUTE MAXIMUM RATINGS 4. THEORY OF OPERATION 4.1 Digital Filters 4.2 Average Real Power Computation 5. FUNCTIONAL DESCRIPTION 11 5.1 Analog Inputs 5.1.1 Voltage Channel 11 5.1.2 Current Channel 11 5.2 High-Pass Filter 11 5.3 Energy Pulse Outputs 11 5.3.1 Pulse Output Format 11 5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 13 5.4 Energy Direction Indicator 15 5.6 Oscillator Characteristics 15 5.7 Basic Application Circuit 15 7. REVISIONS 16 LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT 15 Figure 2. Data Flow 16 Figure 3. Oscillator Connection 17 Figure 4. Typical Connection Diagram 17 LIST OF TABLES Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 11 Table 2. Maximum Frequency for E1, E2 and FOUT 15 Table 2. Maximum Frequency for E1, E2 and FOUT 15 Table 2. Maximum Frequency for E1, E2 and FOUT 16 Table 2. Maximum Frequency for E1, E2 and FOUT 17 Table 2. Maximum Frequency for E1, E2 and FOUT 17 Table 2. Maximum Frequency for E1, E2 and FOUT 17 Table 2. Maximum Frequency for E1, E2 and FOUT 17 Table 2. Maximum Frequency for E1, E2 and FOUT 17 Table 2. Maximum Frequency for E1, E2 and FOUT 17 Table 2. Maximum Frequency for E1, E2 and FOUT 18 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2		VOLTAGE REFERENCE	6
ABSOLUTE MAXIMUM RATINGS 4. THEORY OF OPERATION		DIGITAL CHARACTERISTICS	7
4. THEORY OF OPERATION 11 4.1 Digital Filters 10 4.2 Average Real Power Computation 11 5. FUNCTIONAL DESCRIPTION 11 5.1 Analog Inputs 11 5.1.1 Voltage Channel 11 5.1.2 Current Channel 11 5.2 High-Pass Filter 11 5.3 Energy Pulse Outputs 11 5.3.1 Pulse Output Format 11 5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 13 5.5 Power-on Reset 13 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 13 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection Diagram 12 LIST OF TABLES Table 1. Current Channel PGA Setting			
4.1 Digital Filters 4.2 Average Real Power Computation 5. FUNCTIONAL DESCRIPTION 11 5.1 Analog Inputs 11 5.1.1 Voltage Channel 11 5.1.2 Uigh-Pass Filter 11 5.3 Energy Pulse Outputs 11 5.3.1 Pulse Output Format 11 5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 13 5.5 Power-on Reset 15 5.6 Oscillator Characteristics 15 5.7 Basic Application Circuit 16 6. PACKAGE DIMENSIONS 17 REVISIONS 11 LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT 16 Figure 3. Oscillator Connection 17 Figure 4. Typical Connection Diagram 17 LIST OF TABLES Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12 Table 2. Maximum Frequency for E1, E2 and FOUT 15 Table 2. Maximum Frequency for E1, E2 and FOUT 16 Table 2. Maximum Frequency for E1, E2 and FOUT 17 Table 2. Maximum Frequency for E1, E2 and FOUT 17 Table 2. Maximum Frequency for E1, E2 and FOUT 17 Table 2. Maximum Frequency for E1, E2 and FOUT 17 Table 2. Maximum Frequency for E1, E2 and FOUT 17 Table 2. Maximum Frequency for E1, E2 and FOUT 17 Table 2. Maximum Frequency for E1, E2 and FOUT 18 Table 3. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 2. Maximum Frequency for E1, E2 and FOUT 19 Table 3. Maximum Frequency for E1, E2 and FOUT 19 Table 3. Maximum Frequency for E1, E2 and FOUT 19 Table 3. Maximum Frequency for E1, E2 and FOUT 19 Table 3. Maximum Frequency for E1, E2 and FOUT 19 Table 3. Maximum Frequency for E1, E2 and FOUT 19 Table 3. Maximum Frequency for E1, E2 and FOUT 19 Table 3. Maximum Frequency for E1, E2 and FOUT 19 Table 3. Maximum Frequency for E1, E2 and FOUT 19 Table 3. Maximum Frequency for E1, E2 and FOUT 19 Table 3. Maximum Frequency for E1, E2 and FOUT		ABSOLUTE MAXIMUM RATINGS	
4.2 Average Real Power Computation 10 5. FUNCTIONAL DESCRIPTION 11 5.1 Analog Inputs 11 5.1.1 Voltage Channel 11 5.1.2 Current Channel 11 5.2 High-Pass Filter 11 5.3 Energy Pulse Outputs 11 5.3.1 Pulse Output Format 11 5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 13 5.5 Power-on Reset 13 5.6 Oscillator Characteristics 15 5.7 Basic Application Circuit 15 6. PACKAGE DIMENSIONS 11 7. REVISIONS 116 LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 16 Figure 3. Oscillator Connection 13 Figure 4. Typical Connection Diagram 14 LIST OF TABLES Table 1. Current Channel PGA Setting 17 Table 2. Maximum Frequency for E1, E2 and FOUT 12 Table 2. Maximum Frequency for E1, E2 and FOUT 14 Table 2. Maximum Frequency for E1, E2 and FOUT 15 Table 2. Maximum Frequency for E1, E2 and FOUT 15	4.		
5. FUNCTIONAL DESCRIPTION 11 5.1 Analog Inputs 11 5.1.1 Voltage Channel 11 5.1.2 Current Channel 11 5.2 High-Pass Filter 11 5.3 Energy Pulse Outputs 11 5.3.1 Pulse Output Format 11 5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 13 5.5 Power-on Reset 13 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 13 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES 16 Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 13 Figure 4. Typical Connection Diagram 14 LIST OF TABLES Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12			
5.1 Analog Inputs 11 5.1.1 Voltage Channel 11 5.1.2 Current Channel 11 5.2 High-Pass Filter 11 5.3 Energy Pulse Outputs 11 5.3.1 Pulse Output Format. 11 5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 13 5.5 Power-on Reset 13 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 13 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES 16 Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection Diagram 12 Figure 4. Typical Connection Diagram 14 LIST OF TABLES 15 Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12			
5.1.Î Voltage Channel 11 5.1.2 Current Channel 11 5.2 High-Pass Filter 11 5.3 Energy Pulse Outputs 11 5.3.1 Pulse Output Format 11 5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 13 5.5 Power-on Reset 15 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 15 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 15 Figure 4. Typical Connection Diagram 14 LIST OF TABLES Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12	5.		
5.1.2 Current Channel 11 5.2 High-Pass Filter 11 5.3 Energy Pulse Outputs 11 5.3.1 Pulse Output Format 11 5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 13 5.5 Power-on Reset 13 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 13 6. PACKAGE DIMENSIONS 14 7. REVISIONS 16 LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 13 Figure 4. Typical Connection Diagram 14 LIST OF TABLES Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12		• ,	
5.2 High-Pass Filter 11 5.3 Energy Pulse Outputs 11 5.3.1 Pulse Output Format 11 5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 15 5.5 Power-on Reset 15 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 13 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES 16 Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 15 Figure 4. Typical Connection Diagram 12 LIST OF TABLES 14 Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12			
5.3 Energy Pulse Outputs 11 5.3.1 Pulse Output Format 11 5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 13 5.5 Power-on Reset 13 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 13 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES 16 Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 13 Figure 4. Typical Connection Diagram 14 LIST OF TABLES 14 Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12			
5.3.1 Pulse Output Format. 11 5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 13 5.4 Energy Direction Indicator 13 5.5 Power-on Reset 13 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 15 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 13 Figure 4. Typical Connection Diagram 14 LIST OF TABLES 12 Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12		· · · · · · · · · · · · · · · · · · ·	
5.3.2 Selecting Frequency of E1 and E2 11 5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 13 5.5 Power-on Reset 13 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 13 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES 16 Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 13 Figure 4. Typical Connection Diagram 12 LIST OF TABLES 14 Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12			
5.3.3 Selecting Frequency of FOUT 12 5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 13 5.5 Power-on Reset 13 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 13 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES 16 Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 13 Figure 4. Typical Connection Diagram 14 LIST OF TABLES 14 Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12			
5.3.4 Absolute Max Frequency on E1 and E2 12 5.3.5 E1 and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 13 5.5 Power-on Reset 13 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 13 6. PACKAGE DIMENSIONS 15 7. REVISIONS 15 7. REVISIONS 16 LIST OF FIGURES 16 Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 13 Figure 4. Typical Connection Diagram 14 LIST OF TABLES 14 Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12			
5.3.5 E1 and E2 Frequency Calculation 12 5.4 Energy Direction Indicator 13 5.5 Power-on Reset 13 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 15 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 15 Figure 4. Typical Connection Diagram 12 LIST OF TABLES 14 Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12		5.3.3 Selecting Frequency of FOUI	12
5.4 Energy Direction Indicator 13 5.5 Power-on Reset 13 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 13 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES 16 Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 13 Figure 4. Typical Connection Diagram 14 LIST OF TABLES 14 Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12			
5.5 Power-on Reset 13 5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 13 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 13 Figure 4. Typical Connection Diagram 14 LIST OF TABLES 14 Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12			
5.6 Oscillator Characteristics 13 5.7 Basic Application Circuit 13 6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 13 Figure 4. Typical Connection Diagram 14 LIST OF TABLES Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12			
5.7 Basic Application Circuit			
6. PACKAGE DIMENSIONS 15 7. REVISIONS 16 LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 13 Figure 4. Typical Connection Diagram 14 LIST OF TABLES Table 1. Current Channel PGA Setting 11 Table 2. Maximum Frequency for E1, E2 and FOUT 12			
7. REVISIONS 16 LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT 8 Figure 2. Data Flow 10 Figure 3. Oscillator Connection 13 Figure 4. Typical Connection Diagram 14 LIST OF TABLES Table 1. Current Channel PGA Setting 17 Table 2. Maximum Frequency for E1, E2 and FOUT 12	c		
LIST OF FIGURES Figure 1. Timing Diagram for E1, E2 and FOUT Figure 2. Data Flow Figure 3. Oscillator Connection Figure 4. Typical Connection Diagram 14 LIST OF TABLES Table 1. Current Channel PGA Setting Table 2. Maximum Frequency for E1, E2 and FOUT			
Figure 1. Timing Diagram for $\overline{E1}$, $\overline{E2}$ and FOUT	7.	. REVISIONS	
Figure 1. Timing Diagram for $\overline{E1}$, $\overline{E2}$ and FOUT			
Figure 2. Data Flow			
Figure 3. Oscillator Connection			
LIST OF TABLES Table 1. Current Channel PGA Setting			
LIST OF TABLES Table 1. Current Channel PGA Setting			
Table 1. Current Channel PGA Setting	Fi	igure 4. Typical Connection Diagram	14
Table 2. Maximum Frequency for E1, E2 and FOUT12	LIST O	F TABLES	
Table 2. Maximum Frequency for E1, E2 and FOUT12	т,	able 1. Current Channel PGA Setting	4.4
	T ₂	able 2 Maximum Frequency for F1 F2 and FOLIT	



1. GENERAL DESCRIPTION

The CS5466 is a CMOS monolithic power measurement device with an energy computation engine. The CS5466 combines a programmable gain amplifier, two $\Delta\Sigma$ ADC's and energy-to-frequency conversion circuitry on a single chip.

The CS5466 is designed for energy measurement applications and is optimized to interface to a shunt or current transformer for current measurement, and to a resistive divider or transformer for voltage measurement. The current channel has a programmable gain amplifier (PGA) which provides four full-scale input options. With a single +5 V supply on VA+/AGND, both of the CS5466's input channels accommodate common mode + signal levels between (AGND - 0.25 V) and VA+.

The CS5466 has three pulse output pins: $\overline{E1}$, $\overline{E2}$ and FOUT. $\overline{E1}$ and $\overline{E2}$ can be used to directly drive a mechanical counter or stepper motor, or interface to a micro controller. The FOUT pin conveys average real power at a pulse frequency many times higher than that of the $\overline{E1}$ or $\overline{E2}$ pulse frequency, allowing for high speed calibration.



2. PIN DESCRIPTION

Crystal Out	XOUT		1 •	24	þ	XIN	Crystal In
CPU Clock Output	CPUCLK		2	23	þ	FREQ0	Frequency Select 0
Positive Power Supply	VD+		3	22	þ	Ē1	Energy Output 1
Digital Ground	DGND		4	21	þ	Ē2	Energy Output 2
Gain Select 0	IGAIN0		5	20	þ	FREQ1	Frequency Select 1
Negative Energy Indicator	NEG		6	19	þ	RESET	Reset
Gain Select 1	IGAIN1		7	18	þ	FOUT	High Frequency Output
High Pass Filter Enable	HPF		8	17	þ	FREQ2	Frequency Select 2
Differential Voltage Input	VIN+		9	16	þ	IIN+	Differential Current Input
Differential Voltage Input	VIN-		10	15	þ	IIN-	Differential Current Input
Voltage Reference Output	VREFOUT		11	14	þ	VA+	Positive Analog Supply
Voltage Reference Input	VREFIN		12	13	þ	AGND	Analog Ground
		l					

Olask Canavatav		
Clock Generator		
Crystal Out Crystal In	1, 24	XOUT, XIN - A single stage amplifier inside the chip is connected to these pins and can be used with a crystal to provide the system clock for the device. Alternatively, an external clock can be supplied to the XIN pin to provide the system clock for the device.
CPU Clock Output	2	CPUCLK - Output of on-chip oscillator which can drive one standard CMOS load.
Control Pins		
Gain Select	5, 7	IGAIN1, IGAIN0 - Used to select the current channel input gain range.
Frequency Select	17, 20, 23	FREQ2,FREQ1,FREQ0 - Used to select max pulse output frequency for $\overline{E1}$, $\overline{E2}$, and FOUT.
High Pass Filter Enable	8	HPF - High disables the HPF. Low activates HPF on Voltage channel. Connecting HPF pin to FOUT pin activates HPF on Current channel.
Reset	19	RESET - Low activates Reset.
Energy Pulse Outputs		
Energy Output	21, 22	E1, E2 - Active low alternating pulses with an output frequency that is proportional to the average real power.
High Freq Output	18	FOUT - Outputs energy pulses at a frequency higher than $\overline{E1}$ and $\overline{E2}$ outputs. Used for calibration purposes.
Neg Energy Indicator	6	NEG - High indicates negative energy.
Analog Inputs/Outputs		
Differential Voltage Inputs	9, 10	VIN+, VIN Differential analog input pins for voltage channel.
Voltage Reference Output	11	VREFOUT - The on-chip voltage reference output pin. The voltage reference has a nominal magnitude of 2.5 V and is referenced to the AGND pin on the converter.
Voltage Reference Input	12	VREFIN - Voltage input to this pin establishes the voltage reference for the on-chip modulators.
Differential Current Inputs	16, 15	IIN+, IIN Differential analog input pins for current channel.
Power Supply Connections		
Positive Digital Supply	3	VD+ - The positive digital supply.
Digital Ground	4*	DGND - Digital Ground.
Analog Ground	13	AGND - Analog Ground.
Positive Analog Supply	14	VA+ - The positive analog supply.



3. CHARACTERISTICS/SPECIFICATIONS

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Тур	Max	Unit
Positive Digital Power Supply	VD+	3.135	5.0	5.25	V
Positive Analog Power Supply	VA+	4.75	5.0	5.25	V
Voltage Reference	VREFIN	-	2.5	-	V
Specified Temperature Range	T _A	-40	-	+85	°C

ANALOG CHARACTERISTICS

- Min / Max characteristics and specifications are guaranteed over all Operating Conditions.
- Typical characteristics and specifications are measured at nominal supply voltages and TA = 25 °C.
- VA+ = VD+ = 5 V ±5%; AGND = DGND = 0 V; VREFIN = +2.5 V. All voltages with respect to 0 V.
- MCLK = 4.096 MHz

Parameter		Symbol	Min	Тур	Max	Unit
Analog Inputs (Current Channel)	•		•		•	
Differential Input Range	(Gain = 10)	lin	-	±250	-	mV
$\{(I_{N+})-(I_{N-})\}$	(Gain = 50)		-	±50	-	mV
	(Gain = 100)		-	±25	-	mV
	(Gain = 150)		-	±16.7	-	mV
Input Capacitance	(All Gain Ranges)	Cinl	-	25	-	pF
Effective Input Impedance	(All Gain Ranges)	ZinI	30	-	-	kΩ
Analog Inputs (Voltage Channel)			•	•	•	
Differential Input Range	{(VIN+)-(VIN-)}	Vin	-	-	±250	mV
Input Capacitance		CinV	-	0.2	-	pF
Effective Input Impedance		ZinV	2	-	-	МΩ
Accuracy (Energy Outputs)	•		•	•	•	
Full-Scale Error	(Note 1)	FSE	-	0.1	-	%F.S.

Notes: 1. Applies after system calibration.



ANALOG CHARACTERISTICS (Continued)

Pa	arameter	Symbol	Min	Тур	Max	Unit
Power Supplies						
Power Supply Currents	I _{A+}	PSCA	-	1.3	-	mA
	$I_{D+}(VA+ = VD+ = 5 V)$	PSCD	-	2.9	-	mA
	I_{D+} (VA+ = 5 V, VD+ = 3.3 V)	PSCD	-	1.7	-	mA
Power Consumption	(VA + = VD + = 5 V)	PC	-	21	25	mW
(Note 2)	(VA+ = 5 V, VD+ = 3.3 V)		-	11.6	-	mW
Power Supply Rejection	Ratio (50, 60 Hz)			-	-	
(Note 3)	Voltage Channel (Gain = 10)	PSRR	45	55	-	dB
	Current Channel (Gain = 10)		75	-	-	dB
	(Gain = 50)		56	75	-	dB
	(Gain = 100)		56	75	-	dB
	(Gain = 150)		56	75	-	dB

Notes: 2. All outputs unloaded. All inputs CMOS level.

3. Definition for PSRR: VREFIN tied to VREFOUT, VA+ = VD+ = 5 V, a 150 mV zero-to-peak sine wave (frequency = 60 Hz) is imposed onto the +5 V supply voltage at VA+ and VD+ pins. The "+" and "-" input pins of both input channels are shorted to VA-. Then the CS5466 is put into an internal test mode and digital output data is collected for the channel under test. The zero-peak value of the digital sinusoidal output signal is determined, and this value is converted into the zero-peak value of the sinusoidal voltage that would need to be applied at the channel's inputs, in order to cause the same digital sinusoidal output. This voltage is then defined as Veq. PSRR is then (in dB):

$$PSRR = 20 \cdot log \left\{ \frac{0.150V}{V_{eq}} \right\}$$

VOLTAGE REFERENCE

Parameter		Symbol	Min	Тур	Max	Unit
Reference Output	1					
Output Voltage		REFOUT	+2.4	+2.5	+2.6	V
VREFOUT Temperature Coefficient	(Note 4)	TCVREF		25	60	ppm/°C
Load Regulation	(Note 5)	ΔV_{R}		6	10	mV
Reference Input				•		
Input Voltage Range		VREFIN	+2.4	+2.5	+2.6	V
Input Capacitance			-	4	-	pF
Input CVF Current			-	25	-	nA

Notes: 4. The voltage at VREFOUT is measured across the temperature range. From these measurements the following formula is used to calculate the VREFOUT Temperature Coefficient:.

$$TC_{VREF} = \left(\frac{(VREFOUT_{MAX} - VREFOUT_{MIN})}{VREFOUT_{AVG}}\right) \left(\frac{1}{T_{A}MAX} - T_{A}MIN\right) \left(1.0 \times 10^{6}\right)$$

5. Specified at maximum recommended output current of 1 μ A, source or sink.



DIGITAL CHARACTERISTICS (Note 6)

- Min / Max characteristics and specifications are guaranteed over all Operating Conditions.
- Typical characteristics and specifications are measured at nominal supply voltages and TA = 25 °C.
- VA+ = VD+ = 5V ±5%; AGND = DGND = 0 V. All voltages with respect to 0 V.
- MCLK = 4.096 MHz

Parameter		Symbol	Min	Тур	Max	Unit
Master Clock Characteristics			•	I.		
Master Clock Frequency In	ternal Gate Oscillator	MCLK	3	4.096	5	MHz
Master Clock Duty Cycle			40	-	60	%
CPUCLK Duty Cycle	(Note 7 and 8)		40		60	%
Filter Characteristics						
High Pass Filter Corner Frequency	-3 dB		-	0.125	-	Hz
Input/Output Characteristics						
High-Level Input Voltage	XIN RESET	V _{IH}	(VD+) - 0.5 0.8 VD+	-		V V
Low-Level Input Voltage (VD = 5 V)	XIN RESET	V_{IL}	-		1.5 0.2 VD+	V V
Low-Level Input Voltage (VD = 3.3 V)	XIN RESET	V _{IL}	-		0.3 0.2 VD+	V V
High-Level Output Voltage (except XOI	JT) $I_{out} = +5 \text{ mA}$	V _{OH}	(VD+) - 1.0	-	-	V
Low-Level Output Voltage (except XOL	$I_{out} = -5 \text{ mA}$	V _{OL}	-	-	0.4	V
Input Leakage Current		I _{in}	-	±1	±10	μΑ
Digital Output Pin Capacitance		C _{out}	-	5	-	pF
Drive Current FOUT, E1, E2, NEG	(Note 9)	I _{DR}		90		mA

Notes: 6. All measurements performed under static conditions.

- 7. If external MCLK is used, then the duty cycle must be between 45% and 55% to maintain this specification.
- 8. The frequency of CPUCLK is equal to MCLK.
- 9. V_{OL} and V_{OH} are not specified under this condition.



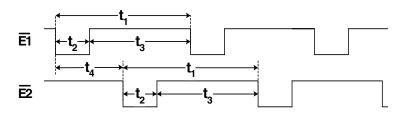
SWITCHING CHARACTERISTICS

- Min / Max characteristics and specifications are guaranteed over all Operating Conditions.
- Typical characteristics and specifications are measured at nominal supply voltages and TA = 25 °C.
- VA+ = 5 V \pm 5% VD+ = 3.3 V \pm 5% or 5 V \pm 5%; AGND = DGND = 0 V. All voltages with respect to 0 V.
- Logic Levels: Logic 0 = 0 V, Logic 1 = VD+.

Para	Symbol	Min	Тур	Max	Unit	
Rise Times (Note 10)	Any Digital Input Any Digital Output	t _{rise}		- 50	1.0 -	μs ns
Fall Times (Note 10)	Any Digital Input Any Digital Output	t _{fall}	-	- 50	1.0 -	μs ns
Start-up						
Oscillator Start-Up Time	XTAL = 4.096 MHz (Note 11)	t _{ost}	-	60	-	ms
E1 and E2 Timing (Note 12 a	and 13)					
Period		t ₁	500		-	ms
Pulse Width		t ₂	250	-	-	ms
Rising Edge to Falling Edge		t ₃	250			ms
E1 Falling Edge to E2 Falling	Edge	t ₄	250		-	ms
FOUT Timing (Note 12 and 1	3)					
Period		t ₅	0.10	1 / f _{FOUT}		ms
Pulse Width	(Note 14)	t ₆	-	0.5*t ₅	90	ms
FOUT low		t ₇	-	0.5*t ₅	-	ms

Notes: 10. Specified using 10% and 90% points on wave-form of interest. Output loaded with 50 pF.

- Oscillator start-up time varies with crystal parameters. This specification does not apply when using an external clock source.
- 12. Pulse output timing is specified at MCLK = 4.096 MHz. Current and voltage signals are at unity power factor. Refer to Section 5.3 for more information on pulse output pins.
- 13. Timing is proportional to the frequency of MCLK.
- 14. When FREQ2 = 0, FREQ1=1 and FREQ0=1, FOUT will have a typical pulse width of 20 μs at MCLK = 4.096 MHz.



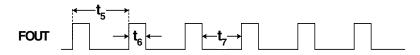


Figure 1. Timing Diagram for $\overline{E1}$, $\overline{E2}$ and FOUT



ABSOLUTE MAXIMUM RATINGS

WARNING: Operation at or beyond these limits may result in permanent damage to the device.

Normal operation is not guaranteed at these extremes.

Parameter	Symbol	Min	Тур	Max	Unit	
DC Power Supplies	(Notes 15 and 16)					
	Positive Digital	VD+	-0.3	-	+6.0	V
	Positive Analog	VA+	-0.3	-	+6.0	V
Input Current, Any Pin Except Supplies	(Notes 17, 18, 19)	I _{IN}	-	-	±10	mA
Output Current, Any Pin Except VREFOU	JT	I _{OUT}	-	-	100	mA
Power Dissipation	(Note 20)	PD	-	-	500	mW
Analog Input Voltage	All Analog Pins	V _{INA}	- 0.3	-	(VA+) + 0.3	V
Digital Input Voltage	All Digital Pins	V_{IND}	-0.3	1	(VD+) + 0.3	V
Ambient Operating Temperature		T_A	-40	-	85	°C
Storage Temperature		T _{stg}	-65	-	150	°C

Notes: 15. VA+ and AGND must satisfy $\{(VA+) - (AGND)\} \le +6.0 \text{ V}$.

- 16. VD+ and AGND must satisfy $\{(VD+) (AGND)\} \le + 6.0 \text{ V}.$
- 17. Applies to all pins including continuous over-voltage conditions at the analog input pins.
- 18. Transient current of up to 100 mA will not cause SCR latch-up.
- 19. Maximum DC input current for a power supply pin is ±50 mA.
- 20. Total power dissipation, including all input currents and output currents.



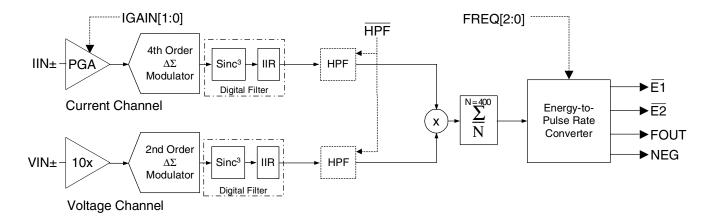


Figure 2. Data Flow

4. THEORY OF OPERATION

The CS5466 is a dual channel Analog-to-Digital Converter (ADC) followed by a computation engine that performs an energy-to-pulse conversion. The flow diagram for the two data paths is depicted in Figure 2. The analog inputs are structured with two dedicated channels, voltage and current, then optimized to simplify interfacing to sensing elements.

The voltage sensing element introduces a voltage waveform on the voltage channel input VIN \pm and is subject to a fixed 10x gain amplifier. A second order deltasigma modulator samples the amplified signal for digitization.

Simultaneously, the current sensing element introduces a voltage waveform on the current channel input IIN± and is subject to the four selectable gains of the Programmable Gain Amplifier (PGA). The amplified signal is sampled by a fourth order delta-sigma modulator for digitization. Both converters sample at a rate of (MCLK)/8, the over-sampling provides a wide dynamic range and simplified anti-alias filter design.

4.1 Digital Filters

The decimating digital filters on both channels are Sinc³ filters followed by 4th-order IIR filters. The single bit data is passed to the low pass decimation filter and output at

a fixed word rate. The output word is passed to the IIR filter to compensate for the magnitude roll-off of the low-pass filtering operation.

An optional digital High-Pass Filter (HPF in Figure 2) removes any dc component from the selected signal path. By removing the dc component from the voltage or current channel, any dc content will also be removed from the calculated average real power as well.

4.2 Average Real Power Computation

The instantaneous voltage and current data samples are multiplied together to obtain the instantaneous power. The product is then averaged over 400 conversions to compute the average real power value used to drive pulse outputs $\overline{E1}$, $\overline{E2}$ and FOUT. Output pulse rate of $\overline{E1}$ and $\overline{E2}$ can be set to one of four frequencies to directly drive a stepper motor or a electromechanical counter or interface to a microcontroller or infrared LED. The alternating output pulses of $\overline{E1}$ and $\overline{E2}$ allows for use with low cost electromechanical counters.

Output FOUT provides a uniform pulse stream that is proportional to the average real power and is designed for system calibration. The FREQ2:0 inputs set the output pulse rate of E1, E2 and FOUT. See Section 5.3 for more details.



5. FUNCTIONAL DESCRIPTION

5.1 Analog Inputs

The CS5466 is equipped with two fully differential input channels. The inputs VIN \pm and IIN \pm are designated as the voltage and current channel inputs, respectively. The full-scale differential input voltage for the current and voltage channel is $\pm 250 \text{ mV}_P$.

5.1.1 Voltage Channel

The output of the line voltage resistive divider or transformer is connected to the VIN+ and VIN- input pins of the CS5466. The voltage channel is equipped with a 10x fixed gain amplifier. The full-scale signal level that can be applied to the voltage channel is ± 250 mV. If the input signal is a sine wave the maximum RMS voltage is:

$$\frac{250mV_P}{\sqrt{2}} \cong 176.78mV_{RMS}$$

which is approximately 70.7% of maximum peak voltage.

5.1.2 Current Channel

The output of the current sense resistor or transformer is connected to the IIN+ and IIN- input pins of the CS5466. To accommodate different current sensing devices the current channel incorporates a Programmable Gain Amplifier (PGA) that can be set to one of four input ranges. Input pins IGAIN1 and IGAIN0 (See Table 1) define the PGA's four gain selections and corresponding maximum input signal level.

IGAIN1	IGAIN0	Maximum Input Range				
0	0	±250mV	10x			
0	1	±50mV	50x			
1	0	±25mV	100x			
1	1	±16.67mV	150x			

Table 1. Current Channel PGA Setting

For example if IGAIN1=IGAIN0=0, the current channel's PGA gain is set to 10x. If the input signals are pure sinusoids with zero phase shift, the maximum peak differential signal on the current or voltage channel is $\pm 250~\text{mV}_P$. The input signal levels are approximately 70.7% of maximum peak voltage producing a full scale energy pulse registration equal to 50% of absolute maximum energy pulse registration. This will be discussed further in Section 5.3.

5.2 High-Pass Filter

By removing the offset from either channel, no error component will be generated at dc when computing the average real power. Input pin HPF defines the three options;

- High-Pass Filter (HPF) is disabled when pin HPF is connected high.
- HPF is enabled in the voltage channel when pin HPF is connected low.
- HPF is enabled in the current channel when pin HPF is connected to pin FOUT.

5.3 Energy Pulse Outputs

The CS5466 provides three output pins for energy registration. The E1 and E2 pins provide a simple interface from which energy can be registered. These pins are designed to directly connect to a stepper motor or electromechanical counter. The pulse rate on the E1 and E2 pins are in the range of 0 to 4 Hz and all frequency settings are optimized to be used with standard meter constants. The FOUT pin is designated for system calibration, the pulse rate can be selected to reach a frequency of 8000 Hz.

5.3.1 Pulse Output Format.

The CS5466 produces alternating pulses on $\overline{E1}$ and $\overline{E2}$. This pulse format is designed to drive a stepper motor. Each pin produces active low pulses with a minimum pulse width of 250 ms when MCLK = 4.096 MHz. Refer to CS5466 Switching Characteristics on page 8 for timing parameters.

The FOUT pin issues active high pulses. The pulse width is equal to 90 ms (typical), unless the period falls below 180 ms. At this time the pulses will be equal to half the period. In mode 3 (FREQ2:0 = 3), the pulse width of all FOUT pulses is typically 20 μ s regardless of the pulse rate (MCLK = 4.096 MHz).

5.3.2 Selecting Frequency of $\overline{E1}$ and $\overline{E2}$

The pulse rate on $\overline{E1}$ and $\overline{E2}$ can be set to one of four frequency ranges. Input pins FREQ1 and FREQ0 (See Table 2) determine the maximum frequency on $\overline{E1}$ and $\overline{E2}$ for pure sinusoidal inputs with zero phase shift. As shown in Figure 1 on page 8, the frequency of $\overline{E2}$ is equal to the frequency of $\overline{E1}$ with active low alternating pulses.

As discussed in Section 5.1.2, the maximum frequency on the $\overline{E1}$ and $\overline{E2}$ output pins is equal to the selected frequency in Table 2 if the maximum peak differential signal applied to both channels is a sine wave with zero phase shift.



Fre	Frequency Select			Maximum Frequency for a Sine Wave (Notes 1, 2 and 3)				
FREQ2	FREQ1	FREQ0	E1 or E2	E1+E2	FOUT			
0	0	0	0.125 Hz	0.25 Hz	64x(E1 + E2)	16 Hz		
0	0	1	0.25 Hz	0.5 Hz	32x(E1 + E2)	16 Hz		
0	1	0	0.5Hz	1.0 Hz	16x(E1 + E2)	16 Hz		
0	1	1	1.0 Hz	2.0 Hz	2048x(E1 + E2)	4,096 Hz		
1	0	0	0.125 Hz	0.25 Hz	128x(E1 + E2)	32 Hz		
1	0	1	0.25 Hz	0.5 Hz	64x(E1 + E2)	32 Hz		
1	1	0	0.5 Hz	1.0 Hz	32x(E1 + E2)	32 Hz		
1	1	1	1.0 Hz	2.0 Hz	16x(E1 + E2)	32 Hz		

Table 2. Maximum Frequency for E1, E2 and FOUT

Notes: 1 A pure sinusoidal input with zero phase shift is applied to the voltage and current channel.

2 MCLK = 4.096 MHz

3 See Figure 1 on page 8 for $\overline{E1}$ and $\overline{E2}$ timing diagram.

5.3.3 Selecting Frequency of FOUT

The pulse output FOUT is designed to assist with meter calibration. Using the FREQ2:0 pins, FOUT can be set to frequencies higher than that of E1 and E2. The FOUT frequency is directly proportional to the E1 and E2 frequencies. Table 2 defines the maximum frequencies for FOUT and the dependency of FOUT on E1 and E2.

5.3.4 Absolute Max Frequency on E1

The CS5466 supports input signals on the voltage and current channel that may not be a sine wave. A typical situation of achieving the absolute maximum frequency on $\overline{E1}$ and $\overline{E2}$ would be if a 250 mV dc signal is applied to the VIN and IIN input pins. The digital high-pass filter should be disengaged by selecting $\overline{HPF}=1$.

The absolute maximum pulse rate observed on $\overline{E1}$ and $\overline{E2}$, determined by the FREQ2:0 selection is defined below in Table 3.

Frequency Select			Absolute Max Frequency		
FREQ2	FREQ1	FREQ0	E1 or E2	E1+E2	
Х	0	0	0.25 Hz	0.5 Hz	
Х	0	1	0.5 Hz	1.0 Hz	

Table 3. Absolute Max Frequency on E1 and E2

Frequency Select			Absolute Max Frequency		
FREQ2 FREQ1		FREQ0	E1 or E2	E1+E2	
х	1	0	1.0 Hz	2.0 Hz	
Х	1	1	2.0 Hz	4.0 Hz	

Table 3. Absolute Max Frequency on E1 and E2

5.3.5 E1 and E2 Frequency Calculation

The pulse output frequency of $\overline{E1}$ and $\overline{E2}$ is directly proportional to the average power calculated from the input signals. To calculate the output frequency on $\overline{E1}$ and $\overline{E2}$, use the following transfer function:

$$FREQE1,E2 = \frac{VIN * 10 * IIN * IGAIN * FREQmax}{VREFIN^{2}}$$

FREQE1,E2 = Actual frequency of $\overline{E1}$ and $\overline{E2}$ pulses [Hz] VIN = rms voltage across VIN+ and VIN- [V] IIN = rms voltage across IIN+ and IIN- [V] IGAIN = Current channel gain selection (10, 50, 100, 150) FREQmax = Absolute Max Frequency for $\overline{E1}$ and $\overline{E2}$ [Hz] VREFIN = Voltage at VREFIN pin [V]



Example:

For a given application, assuming a 50 Hz line frequency and a purely resistive load (unity power factor), the following configuration is used:

- FREQ2:0 = 3 ∴ FREQ_{max} = 2 Hz
- IGAIN1:0 = 2 ∴ IGAIN = 100
- VREFIN = VREFOUT = 2.5 V

In this configuration the maximum sine wave that can be applied is 250 mVp on the voltage channel and 25 mVp on the current channel. Using the above formula, the output frequency of $\overline{E1}$ or $\overline{E2}$ is calculated:

$$\frac{.25V_p * 10 * .025V_p * 100 * 2Hz}{\sqrt{2} * \sqrt{2} * 2.5V^2} = 1Hz$$

With maximum pure sinusoidal input signals, the frequency of $\overline{E1}$ or $\overline{E2}$ is half the absolute maximum frequency set with FREQ2:0.

To calculate the frequency of FOUT for the example above, assume FREQ2 = 0.

$$FOUT = 2048*(\overline{E1} + \overline{E2}) = 2048*(2Hz) = 4096Hz$$

5.4 Energy Direction Indicator

The NEG pin indicates the sign of the calculated average power. If negative average power is detected the NEG output pin will become active high and will remain active high until positive average power is detected. The $\underline{\text{NEG pin}}$ is valid at least 250ns prior to any assertion of $\overline{\text{E1}}$ or $\overline{\text{E2}}$, and FOUT, to indicate the sign of a given energy output. The NEG pin is updated at a rate of 10 Hz at MCLK = 4.096 MHz.

5.5 Power-on Reset

Upon powering up, the digital circuitry is held in reset until the analog voltage reaches 4.0 V. At that time, an eight XIN clock period delay is enabled to allow the oscillator to stabilize. The CS5466 will then initialize. The device reads the control pins IGAIN1:0, FREQ2:0 and HPF, and begins performing energy measurements.

5.6 Oscillator Characteristics

XIN and XOUT are the input and output of an inverting amplifier which can provide oscillation and can be configured as an on-chip oscillator, as shown in Figure 3. The oscillator circuit is designed to work with a quartz crystal. To reduce circuit cost, two load capacitors C1

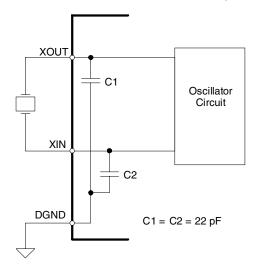


Figure 3. Oscillator Connection

and C2 are integrated in the device, one between XIN and DGND, one between XOUT and DGND. Lead lengths should be minimized to reduce stray capacitance. To drive the device from an external clock source, XOUT should be left unconnected while XIN is driven by the external circuitry. There is an amplifier between XIN and the digital section which provides CMOS level signals. This amplifier works with sinusoidal inputs so there are no problems with slow edge times.

5.7 Basic Application Circuit

Figure 4 shows the CS5466 configured to measure power in a single-phase 2-wire system while operating in a single supply configuration. In this diagram, a shunt resistor is used to sense the line current and a voltage divider is used to sense the line voltage. In this type of shunt resistor configuration, the common-mode level of the CS5466 must be referenced to the line side of the power line. This means that the common-mode potential of the CS5466 will track the high voltage levels, as well as low voltage levels, with respect to earth ground potential.



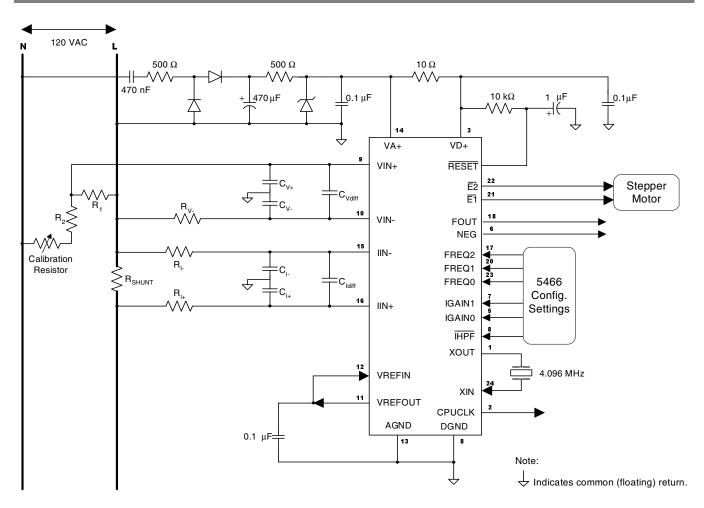
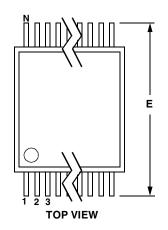


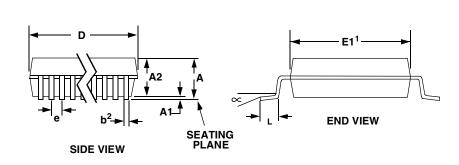
Figure 4. Typical Connection Diagram



6. PACKAGE DIMENSIONS

24L SSOP PACKAGE DRAWING





	INCHES			MILLIMETERS			NOTE
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α			0.084			2.13	
A1	0.002	0.006	0.010	0.05	0.13	0.25	
A2	0.064	0.068	0.074	1.62	1.73	1.88	
b	0.009		0.015	0.22		0.38	2,3
D	0.311	0.323	0.335	7.90	8.20	8.50	1
E	0.291	0.307	0.323	7.40	7.80	8.20	
E1	0.197	0.209	0.220	5.00	5.30	5.60	1
е	0.022	0.026	0.030	0.55	0.65	0.75	
L	0.025	0.03	0.041	0.63	0.75	1.03	
∞	0°	4°	8°	0°	4°	8°	

JEDEC #: MO-150

Controlling Dimension is Millimeters.

- Notes: 1. "D" and "E1" are reference datums and do not included mold flash or protrusions, but do include mold mismatch and are measured at the parting line, mold flash or protrusions shall not exceed 0.20 mm per side.
 - 2. Dimension "b" does not include dambar protrusion/intrusion. Allowable dambar protrusion shall be 0.13 mm total in excess of "b" dimension at maximum material condition. Dambar intrusion shall not reduce dimension "b" by more than 0.07 mm at least material condition.
 - 3. These dimensions apply to the flat section of the lead between 0.10 and 0.25 mm from lead tips.



7. REVISIONS

Revision	Date	Changes	
PP1	September 2004	Initial Release	
PP2	October 2004	Corrected table heading on Page 6.	

Contacting Cirrus Logic Support

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